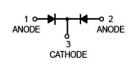




Features:

- Very Small Plastic SMD Package
- High Switching Speed: 4ns (Max.)
- Continuous Reverse Voltage: 75V (Max.)
- Repetitive Peak Reverse Voltage: 85V (Max.)
- Repetitive Peak Forward Current: 500mA (Max.)





Applications:

High-speed switching in e.g. surface mounted circuits

SOT-523

Max. Rating @ TA = 25°C unless otherwise specified

Parameter		Symbol	Limits	Unit
Peak repetitive reverse voltage		VRRM	85	V
Continuous reverse voltage		VR	75	V
RMS reverse voltage		Vr(rms)	53	V
Forward continuous current (Max.)	Single diode loaded Both diodes loaded	lғм	150 75	mA
Repetitive peak forward current		IFRM	500	mA
Non-repetitive peak forward surge cu	rrent @t = 1µs @t = 1ms @t = 1s	IFSM	4 1 0.5	А
Total power dissipation Ts = 90°C; on	e diode loaded	P _{tot}	170	mW
Junction and storage temperature		Т _{ј,} Тѕтс	-65 to +150	°C

Electrical Characteristics @ TA = 25°C unless otherwise specified

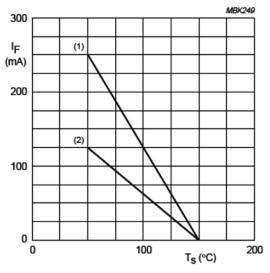
Parameter	Symbol	Conditions	Min.	Max.	Unit
Leakage current	lr	VR = 25V VR = 75V VR = 25V, Tj = 150°C VR = 75V, Tj = 150°C	-	30 2 60 100	nA μA μA μA
Forward voltage	VF	IF = 1mA IF = 10mA IF = 50mA IF = 150mA	-	0.715 0.855 1 1.25	V
Diode capacitance	Сп	V _R =0V, f=1MHz	-	1.5	pF
Forward recovery voltage	V _{ff}	I _F = 10mA, t _r = 20ns	-	1.75	V
Reverse recovery time	trr	$I_F = I_R = 10 \text{mA},$ $I_{TT} = 0.1 \times I_R, R_L = 100 \Omega$	-	4	ns

www.element14.com www.farnell.com www.newark.com



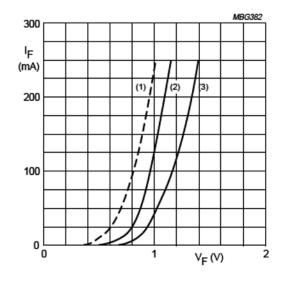


Typical Characteristics @ TA = 25°C unless otherwise specified



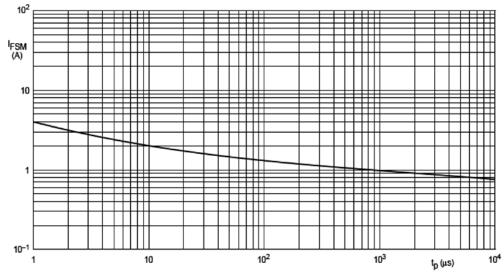
- (1) One diode loaded.
- (2) Both diodes loaded.

Fig.2 Maximum permissible continuous forward current per diode as a function of soldering point temperature.



- (1) T_j = 150 °C; typical values.
- (2) T_i = 25 °C; typical values.
- (3) T_i = 25 °C; maximum values.

Fig.3 Forward current as a function of forward voltage.



Based on square wave currents. T_i = 25 °C prior to surge.

Fig.4 Maximum permissible non-repetitive peak forward current as a function of pulse duration.



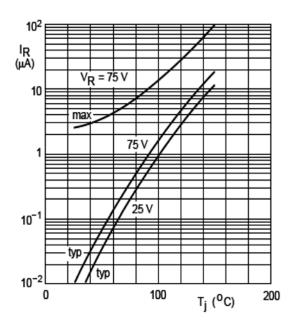
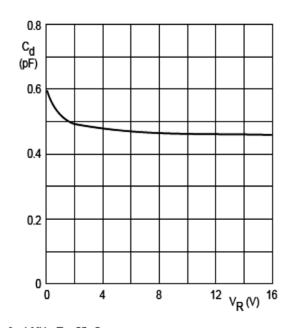


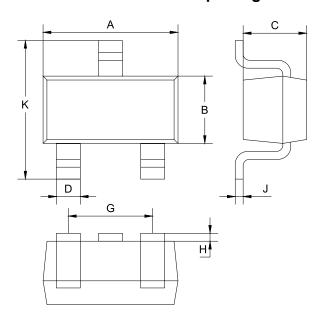
Fig.5 Reverse current as a function of junction temperature.



f = 1 MHz; $T_i = 25 \text{ °C}$.

Fig.6 Diode capacitance as a function of reverse voltage; typical values.

Plastic surface mounted package



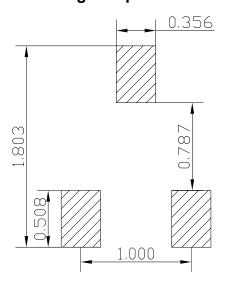
SOT-523		
Dim	Min	Max
Α	1.5	1.7
В	0.75	0.85
С	0.6	0.8
D	0.15	0.3
G	0.9	1.1
Н	0.02	0.1
J	0.1Typical	
K	1.45	1.75
All Dimensions in mm		

www.element14.com www.farnell.com www.newark.com





Soldering Footprint



Package Information

Device	Package	Shipping
BAV70T-7-F	SOT-523	3,000 / Tape & Reel

Unit: mm

Part Number Table

Description	Part Number	
High-speed double Diode	BAV70T-7-F	

Important Notice: This data sheet and its contents (the "Information") belong to the members of the Premier Farnell group of companies (the "Group") or are licensed to it. No licence is granted for the use of it other than for information purposes in connection with the products to which it relates. No licence of any intellectual property rights is granted. The Information is subject to change without notice and replaces all data sheets previously supplied. The Information supplied is believed to be accurate but the Group assumes no responsibility for its accuracy or completeness, any error in or omission from it or for any use made of it. Users of this data sheet should check for themselves the Information and the suitability of the products for their purpose and not make any assumptions based on information included or omitted. Liability for loss or damage resulting from any reliance on the Information or use of it (including liability resulting from negligence or where the Group was aware of the possibility of such loss or damage arising) is excluded. This will not operate to limit or restrict the Group's liability for death or personal injury resulting from its negligence. Multicomp is the registered trademark of the Group. © Premier Farnell plc 2012.

www.element14.com www.farnell.com www.newark.com

